

PARA LIGHT ELECTRONICS CO., LTD.

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DATA SHEET

PART NO.: L-C195JRWDT-5A-U1

REV: <u>A / 4</u>

CUSTOMER'S APPROVAL:

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DCC:

DRAWING NO.: DS-78-14-0009

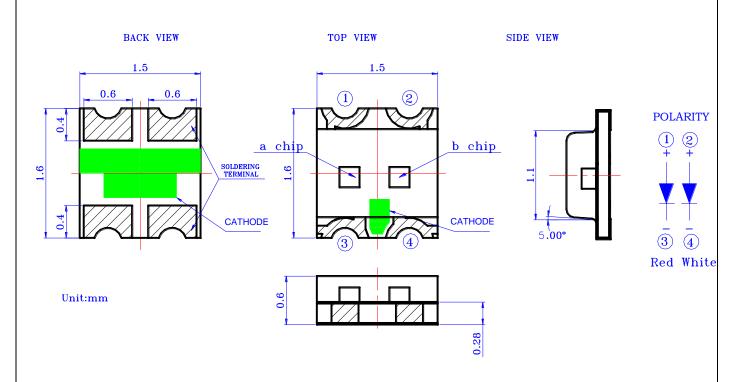
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Part No.: L-C195JRWDT-5A-U1

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PACKAGE OUTLINE DIMENSIONS



Notes:

- 1. a chip: Red; b chip: White
- 2. All dimensions are in millimeters.
- 3. Tolerance is \pm 0.1mm (.004") unless otherwise noted.

Features

- * Dual color, top view, wide view angle Chip LED.
- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic Pick & Place equipment.
- * Compatible with Reflow soldering and Wave soldering processes.
- * EIA STD package.
- * I.C. compatible.
- * Pb free product.
- * Moisture sensitivity level: 3



Part No.: L-C195JRWDT-5A-U1

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• Chip Materials

| Chip | Light Color | Dice Material | Lens Color |
|------|-------------|---------------|-----------------|
| а | JR: Red | AlInGap | Vallow Diffused |
| b | W: White | InGaN | Yellow Diffused |

• Absolute Maximum Ratings (Ta=25°C)

| Symbol | Deremeter | Ratin | Unit | |
|--------|---|--------------|-----------|------|
| Symbol | Parameter | Red | Red White | |
| PD | Power Dissipation | 75 | 100 | mW |
| Inc | Peak Forward Current | 80 | 100 | mA |
| Ipf | (1/10 Duty Cycle, 0.1ms Pulse Width) | 80 | 100 | IIIA |
| IF | Continuous Forward Current | 30 | 20 | mA |
| VR | Reverse Voltage | 5 | 5 | V |
| ESD | Electrostatic Discharge Threshold (HBM) ^{Note A} | 2000 | 1000 | V |
| Topr | Operating Temperature Range | -40 ~ +85 °C | | °C |
| Tstg | Storage Temperature Range | -40 ~ + | -85 | °C |

Note A:

HBM: Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

• Electro-Optical Characteristics (Ta=25°C)

| | SYMBOL | | PARAMETER | TEST CONDITION | MIN. | TYP. | MAX. | UNIT |
|-----------|--|---------------------------------|----------------------|-------------------------|------|------|------|------|
| | VF | White | Forward Voltage | IF = 5mA | 2.6 | 2.9 | 3.0 | V |
| VF | VF | Red | Forward voltage | IF = SITA | 1.8 | 2.0 | 2.4 | |
| | N7 | White | Luminous Intensity | IF = 5mA | 45 | 112 | 180 | mcd |
| IV | IV | Red | | IF = SITA | 7.1 | 18 | 28 | |
| | Х | | IF = 5m | | | 0.29 | | |
| | Y | White | CIE Chromaticity | IF = 5mA | | 0.28 | | |
| | 201/2 | | Half Intensity Angle | IF = 5mA | | 130 | | deg |
| | λD | Red | Dominant Wavelength | IF = 5mA | 625 | 630 | 635 | nm |
| | Δλ | Δλ Red Spectral Line Half-Width | | IF = 5mA | | 19 | | nm |
| | IR | White | Reverse Current | VR = 5V | | | 50 | ۸ |
| | | Red | | VIX = 5V | | | 10 | μA |
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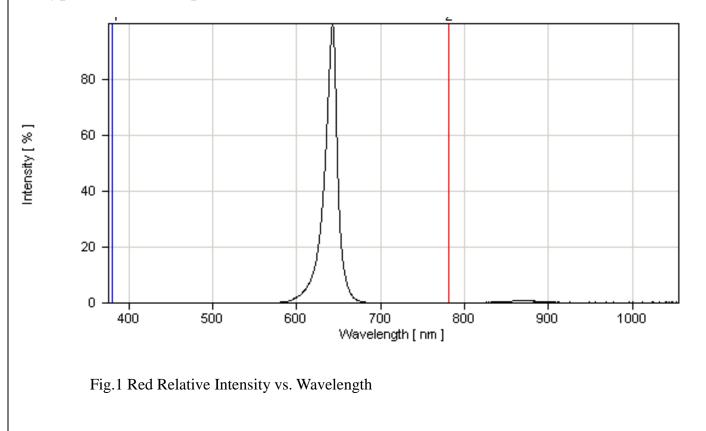
Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4. Caution in ESD:

Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

5. Major standard testing equipment by "Instrument System" Model: CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model: 2400.

• Typical Electro-Optical Characteristics Curves



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Red Typical Electro-Optical Characteristics Curves

(25°CAmbient Temperature Unless Otherwise Noted)

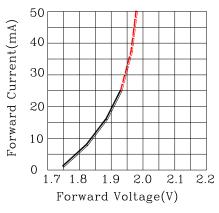


Fig.2 Forward Current vs.Forward Voltage

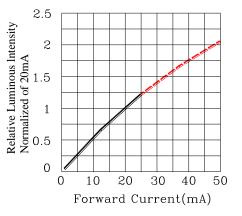
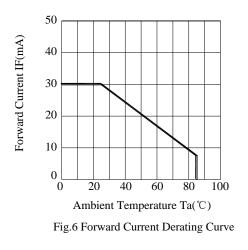


Fig.4 Relative Luminous Intensity vs.Forward Current



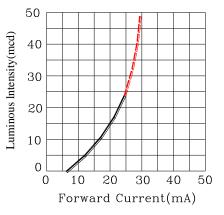


Fig.3 Luminous Intensity vs.Forward Current

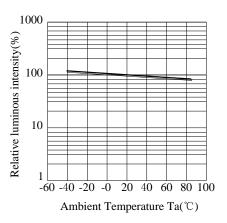
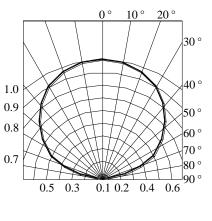
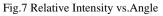


Fig.5 Luminous Intensity vs.Ambient Temperature





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Part No.: L-C195JRWDT-5A-U1

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• White Typical Electro-Optical Characteristics Curves

(25°CAmbient Temperature Unless Otherwise Noted)

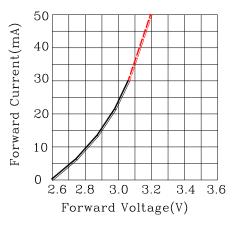
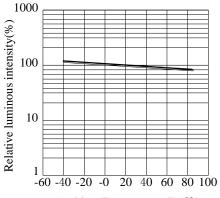
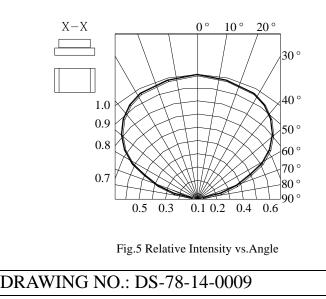


Fig.1 Forward Current vs.Forward Voltage



Ambient Temperature Ta(℃)

Fig.3Luminous Intensity vs.Ambient Temperature



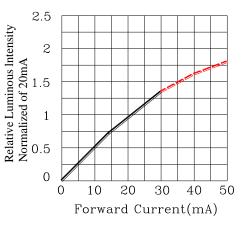


Fig.1 Relative Luminous Intensity vs.Forward Current

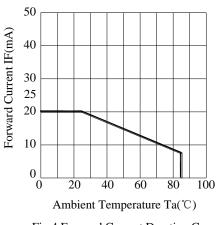
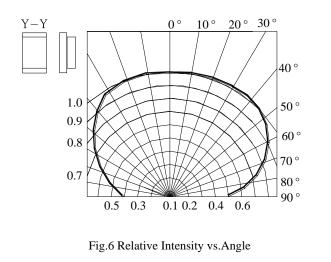


Fig.4 Forward Current Derating Curve



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Part No.: L-C195JRWDT-5A-U1

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• Label Explanation



ITEM CODE:PARRA LIGHT

PART NO: L-C195JRWDT-5A-U1 IV --- Luminous Intensity Code LOT NO: EM S L 12 0110 09 В С D E F А A---EM: Emos Code B---S:SMD L---Local D----Year E---Month F---SPEC. PACKING QUANTITY OF BAG: 3000pcs for 150, 170, 110, 155, 115 series 4000pcs for 191 series 5000pcs for 192 series DATE CODE: <u>2012</u> <u>09</u> <u>10</u> G Η Ι G--- Year H---- Month I --- Day

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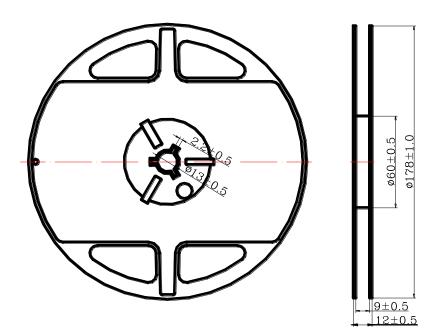
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Part No.: L-C195JRWDT-5A-U1

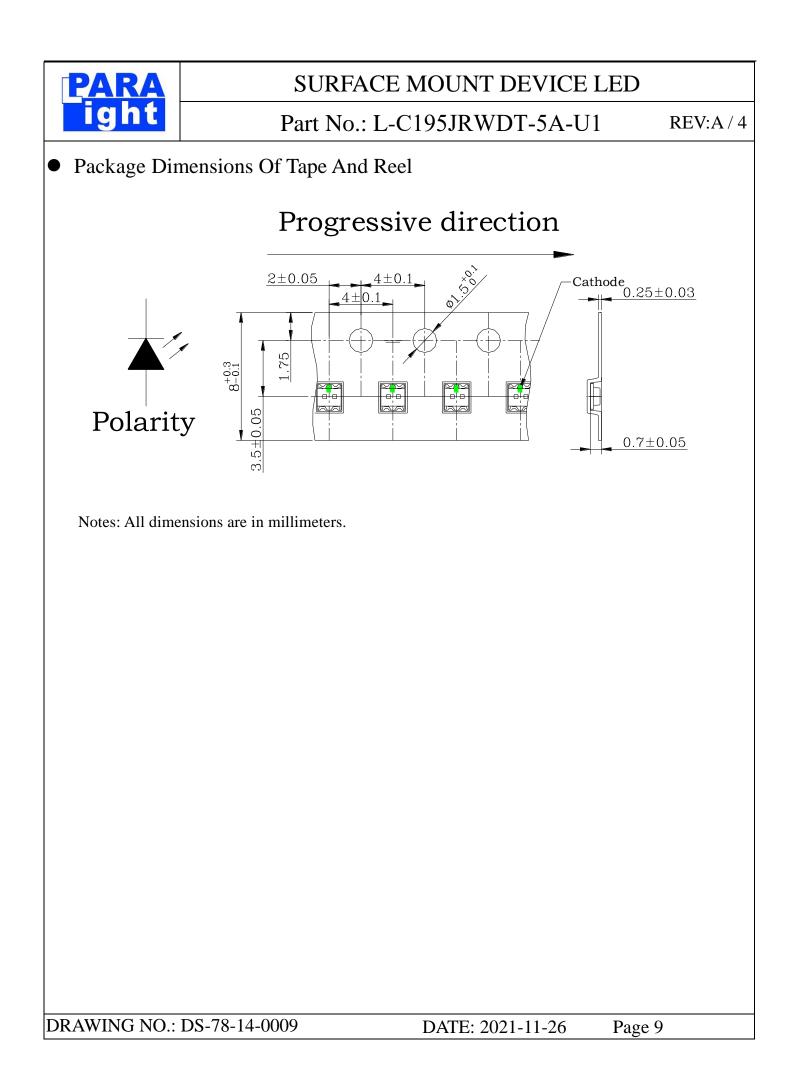
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• Reel Dimensions



Notes:

- 1. Taping Quantity: 3000pcs
- 2. The tolerances unless mentioned is $\pm 0.1 \text{mm}$, Angle $\pm 0.5^\circ\,$, Unit: mm.





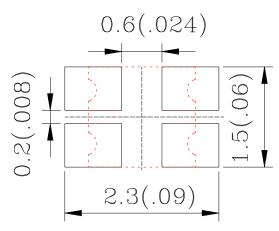
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Cleaning

- * If cleaning is required, use the following solutions for less than 1 minute and less than 40°C.
- * Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as * the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

Suggest Soldering Pad Dimensions



Direction of PWB camber and go to reflow furnace

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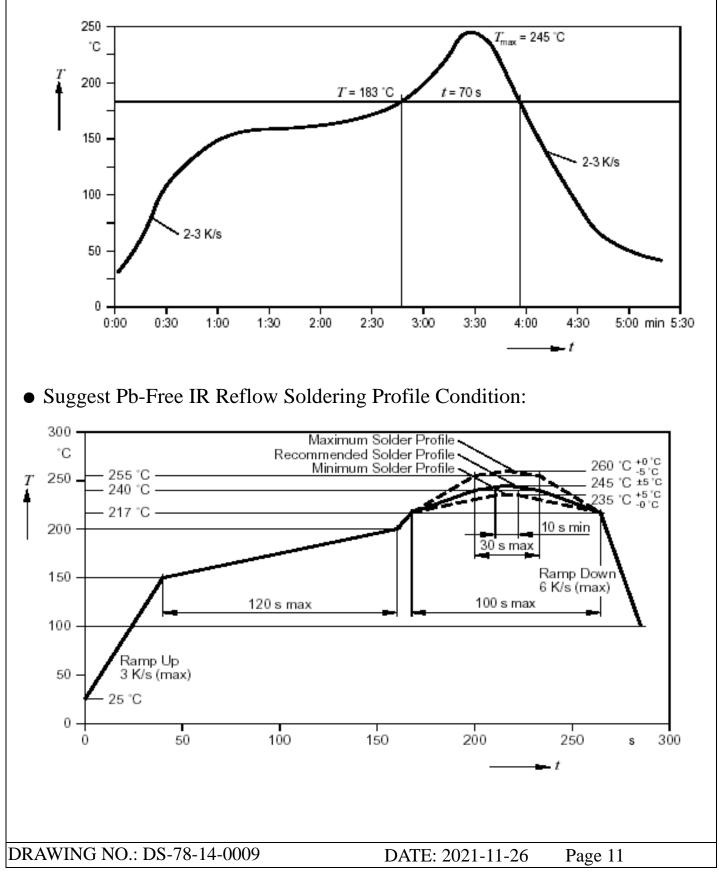
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• Suggest Sn/Pb IR Reflow Soldering Profile Condition:





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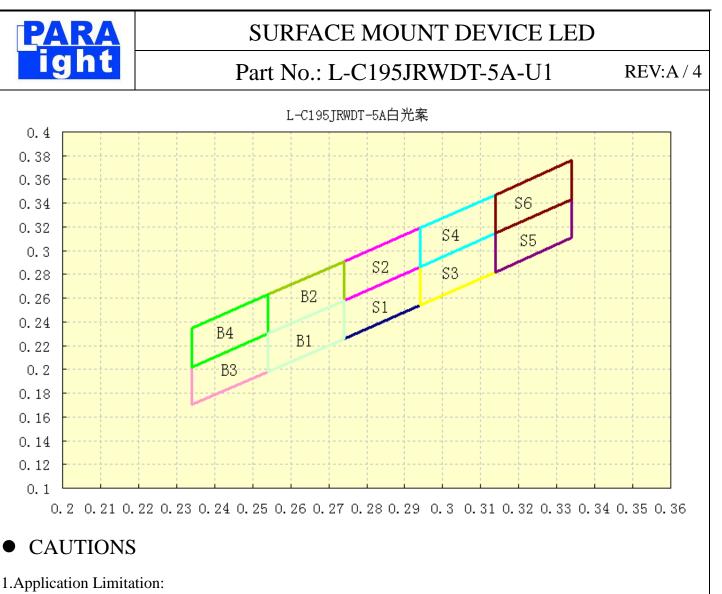
• Bin Code List

| | | | Lumi | nous I | ntensity (| IV), U | nit: mcd@ | 5mA | | | |
|--------------|----------|-------|----------|---------|------------|-----------------|------------------|--------|-------|-------|--|
| Red (a chip) | | | | | | White (b chip) | | | | | |
| В | Sin Code | Min | | Max | | Bin Code | | Min | | Max | |
| | K | 7.1 | | 11.2 | | Р | | 45 | | 71 | |
| L | 1 | 11.2 | | 18 | | Q | 71 | 112 | | | |
| | М | | 18 | 28 | | | R | 112 | | 180 | |
| | | | ŗ | Folera | nce of eac | h bin | are $\pm 15\%$ | | | | |
| | | - | Fo | rward | Voltage(V | /F), U | nit:V@5m | A | | | |
| | | - | | | White | | | | | | |
| | | - | Bin C | ode | | lin | M | | | | |
| | | - | <u> </u> | | | <u>60</u> 70 | 2.2 | | | | |
| | | - | 12 | | | 80 | 2.0 | | | | |
| | | - | 14 | | | 90 | 3.0 | | | | |
| | | | - | Folerar | nce of eac | h bin a | are ± 0.1 Vo | lt | | | |
| | | | Color H | Rank (| CIE chroi | naticit | y X , Y) @ | 5mA | | | |
| Rank B3 | | | | Rank B4 | | | | | | | |
| Х | 0.234 | 0.234 | 0.25 | 54 | 0.254 | Х | 0.234 | 0.234 | 0.254 | 0.254 | |
| Y | 0.17 | 0.202 | 0.2 | 3 | 0.198 | Y | 0.202 | 0.235 | 0.263 | 0.23 | |
| | | Rank | к B2 | | | | | Rank E | 81 | | |
| Х | 0.254 | 0.254 | 0.27 | 74 | 0.274 | Х | 0.274 | 0.254 | 0.254 | 0.274 | |
| Y | 0.23 | 0.263 | 0.29 | 91 | 0.258 | Y | 0.258 | 0.23 | 0.198 | 0.226 | |
| | | Ranl | x S1 | | | Rank S2 | | | | | |
| Х | 0.274 | 0.274 | 0.29 | 94 | 0.294 | Х | 0.274 | 0.274 | 0.294 | 0.294 | |
| Y | 0.226 | 0.258 | 0.28 | 36 | 0.254 | Y | 0.258 | 0.291 | 0.319 | 0.286 | |
| Rank S3 | | | | | Rank S4 | | | | | | |
| Х | 0.294 | 0.294 | 0.31 | 4 | 0.314 | Х | 0.294 | 0.294 | 0.314 | 0.314 | |
| Y | 0.254 | 0.286 | 0.31 | 5 | 0.282 | Y | 0.286 | 0.319 | 0.347 | 0.315 | |
| | | Ranl | < S5 | | | | | Rank S | 6 | | |
| Х | 0.314 | 0.314 | 0.33 | 34 | 0.334 | Х | 0.314 | 0.314 | 0.334 | 0.334 | |
| Y | 0.282 | 0.315 | 0.34 | 13 | 0.311 | Y | 0.315 | 0.347 | 0.376 | 0.343 | |

* Measurement of Color coordinates : +/- 0.02

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The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application). Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage:

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less. If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: $60\pm5^{\circ}$ C for 24 hours.

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3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering condition.

Reflow Soldering:

Pre-heat 120~150 °C, 120sec. MAX., Peak temperature : 240 °C Max. Soldering time: 10 sec Max. Soldering Iron: (Not recommended)

Temperature 300 °C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering. Wave soldering:

Pre-heat 100 °C Max, Pre-heat time 60 sec. Max, Solder wave 260 °C Max, Soldering time 5 sec. Max. preformed consecutively cooling process is required between 1^{st} and 2^{nd} soldering processes.

4. Lead-Free Soldering

For Reflow Soldering:

- 1、Pre-Heat Temp:150-180°C,120sec.Max.
- 2. Soldering Temp: Temperature Of Soldering Pot Over 230°C,40sec.Max.
- 3. Peak Temperature: 260°C , 5sec.
- 4. Reflow Repetition:2 Times Max.
- 5. Suggest Solder Paste Formula 93.3 Sn/3.1 Ag/3.1 Bi /0.5 Cu

For Soldering Iron (Not Recommended):

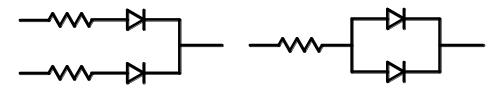
- 1. Iron Tip Temp:350°C Max.
- 2. Soldering Iron:30w Max.
- 3. Soldering Time: 3 Sec. Max. One Time.

For Dip Soldering:

- 1. Pre-Heat Temp:150°C Max. 120 Sec. Max.
- 2、Bath Temp:265[°]℃ Max.
- 3、Dip Time:5 Sec. Max.
- 5. Drive Method

Circuit model A

Circuit model B



(A)Recommended circuit.

(B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.